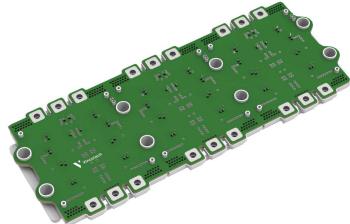
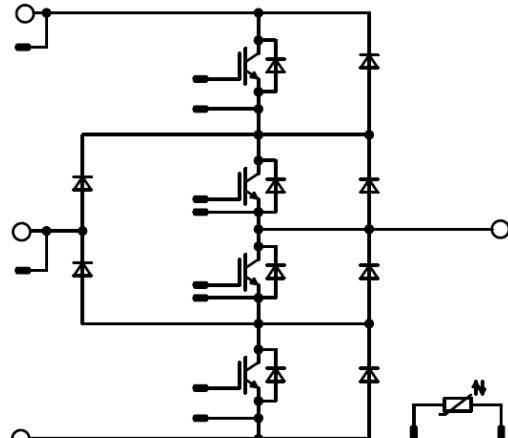




Vincotech

VINcoNPC X12		1500 V / 1200 A
Features		VINco X12 housing
<ul style="list-style-type: none">• Low inductive package• Enables four-quadrant operation• High efficiency		
Target applications		Schematic
<ul style="list-style-type: none">• Solar Inverters• UPS		
Types		
<ul style="list-style-type: none">• 70-W624NIA1K2M702-L400FP70		

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Buck Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	1270	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	2400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	2375	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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Buck Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$	826	A
Repetitive peak forward current	I_{FRM}		2400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	1358	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Buck Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$	104	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	270	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Switch

Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$	1270	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	2400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	2375	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$	826	A
Repetitive peak forward current	I_{FRM}		2400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	1358	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Boost Sw.Inv.Diode				
Peak repetitive reverse voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	826	A
Repetitive peak forward current	I_{FRM}		2400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	1358	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Boost Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	104	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	270	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{op}		-40...($T_{jmax} - 25$)	$^\circ\text{C}$
Maximum allowed PCB temperature	T_{PCB}		125	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	4000	V
		AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				min. 12,7	mm
Clearance				min. 12,7	mm
Comparative Tracking Index	CTI			> 200	

*100 % tested in production



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datasheet

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Characteristic Values

Parameter	Symbol	Conditions						Value			Unit	
		V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_j [°C]	V_{GS} [V]	V_{DS} [V]	I_F [A]	Min	Typ	Max

Buck Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,12	25		5,4	6	6,6	V
Collector-emitter saturation voltage	V_{CESat}		15		1200	125 150			1,53 1,70 1,75	2,05	V
Collector-emitter cut-off current	I_{CES}		0	1200		25				1320	µA
Gate-emitter leakage current	I_{GES}		20	0		25				6	µA
Internal gate resistance	r_g							none			Ω
Input capacitance	C_{ies}		0	10	25			252			nF
Output capacitance	C_{oes}										
Reverse transfer capacitance	C_{res}										
Gate charge	Q_g		15	600	1200	25			7800		nC

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4 \text{ W/mK}$						0,040		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 0,417 \Omega$ $R_{gon} = 0,417 \Omega$	16/-8	600	1190	25		166			ns
Rise time	t_r					125		152			
						150		154			
Turn-off delay time	$t_{d(off)}$	$R_{goff} = 0,417 \Omega$ $R_{gon} = 0,417 \Omega$	16/-8	600	1190	25		42			mWs
Fall time	t_f					125		45			
						150		47			
Turn-on energy (per pulse)	E_{on}	$Q_{rFWD} = 122 \mu\text{C}$ $Q_{rFWD} = 194 \mu\text{C}$ $Q_{rFWD} = 207 \mu\text{C}$	16/-8	600	1190	25		217			mWs
Turn-off energy (per pulse)	E_{off}					125		249			
						150		257			
						25		74			
						125		85			
						150		101			
						25		88			
						125		110			
						150		117			
						25		77			
						125		108			
						150		117			



70-W624NIA1K2M702-L400FP70

datasheet

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Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_c [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Buck Diode

Static

Forward voltage	V_F				1200	25 125		1,82 1,96	2,1	V
Reverse leakage current	I_R			1200		25			720	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						0,07		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt = 20584$ A/µs $di/dt = 24636$ A/µs $di/dt = 23099$ A/µs	16/-8	600	1190	25 125 150		1081 1228 1262		A
Reverse recovery time	t_{rr}					25 125 150		270 408 431		ns
Recovered charge	Q_r					25 125 150		122 194 207		µC
Reverse recovered energy	E_{rec}					25 125 150		42,0 73,7 78,2		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		13899 12695 12576		A/µs

Buck Sw. Protection Diode

Static

Forward voltage	V_F				90	25		2,38	2,71	V
Reverse leakage current	I_R			1200		25 150			0,36 10,8	mA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						0,35		K/W
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70-W624NIA1K2M702-L400FP70

datasheet

Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit	
		V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_j [°C]	V_{GS} [V]	V_{DS} [V]	I_F [A]	Min	Typ	Max

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,12	25		5,4	6	6,6	V
Collector-emitter saturation voltage	V_{CESat}		15		1200	125 150			1,53 1,70 1,75	2,05	V
Collector-emitter cut-off current	I_{CES}		0	1200		25				1320	µA
Gate-emitter leakage current	I_{GES}		20	0		25				6	µA
Internal gate resistance	r_g								none		Ω
Input capacitance	C_{ies}		0	10	25				252		nF
Output capacitance	C_{oes}								8,4		
Reverse transfer capacitance	C_{res}								3,36		
Gate charge	Q_g		15	600	1200	25			7800		nC

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4 \text{ W/mK}$							0,040		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 0,417 \Omega$ $R_{gon} = 0,417 \Omega$	16/-8	600	1179	25		163			ns
Rise time	t_r					125		156			
Turn-off delay time	$t_{d(off)}$					150		157			
Fall time	t_f	$Q_{rFWD} = 119 \mu\text{C}$ $Q_{rFWD} = 192 \mu\text{C}$ $Q_{rFWD} = 216 \mu\text{C}$	25	125	227						mWs
Turn-on energy (per pulse)	E_{on}					150		44			
Turn-off energy (per pulse)	E_{off}					150		42			
						25		45			
						125		250			
						150		263			
						25		71			
						125		95			
						150		103			
						25		85			
						125		98			
						150		104			
						25		76			
						125		107			
						150		114			



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datasheet

Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_c [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Boost Diode

Static

Forward voltage	V_F				1200	25 125		1,82 1,96	2,1	V
Reverse leakage current	I_R			1200		25			720	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4 \text{ W/mK}$						0,07		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt = 21875 \text{ A/}\mu\text{s}$ $di/dt = 26999 \text{ A/}\mu\text{s}$ $di/dt = 25438 \text{ A/}\mu\text{s}$	16/-8	600	1179	25 125 150		951 1173 1199		A
Reverse recovery time	t_{rr}					25 125 150		286 413 452		ns
Recovered charge	Q_r					25 125 150		119 192 216		µC
Reverse recovered energy	E_{rec}					25 125 150		41 72 82		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		7710 8389 8083		A/µs

Boost Sw.Inv.Diode

Static

Forward voltage	V_F				1200	25 125		1,82 1,96	2,1	V
Reverse leakage current	I_R			1200		25			720	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4 \text{ W/mK}$						0,07		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----



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Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_c [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Boost Sw. Protection Diode

Static

Forward voltage	V_F				90	25		2,38	2,71	V
Reverse leakage current	I_R			1200		25	150		0,36 10,8	mA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4 \text{ W/mK}$						0,35		K/W
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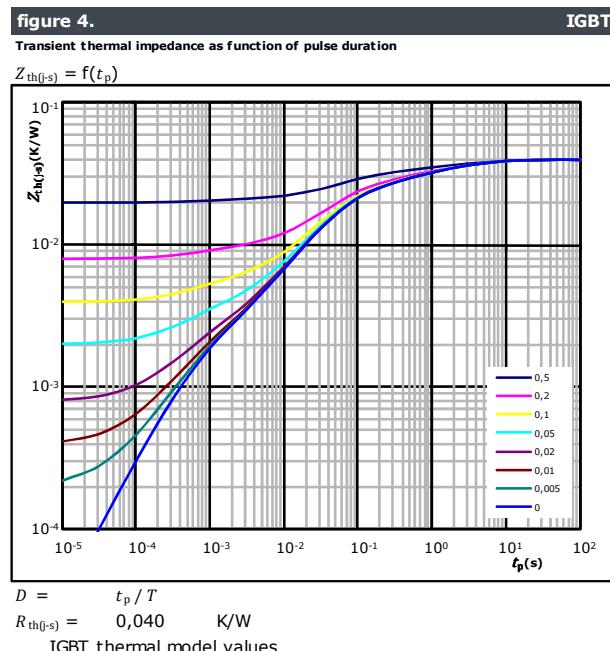
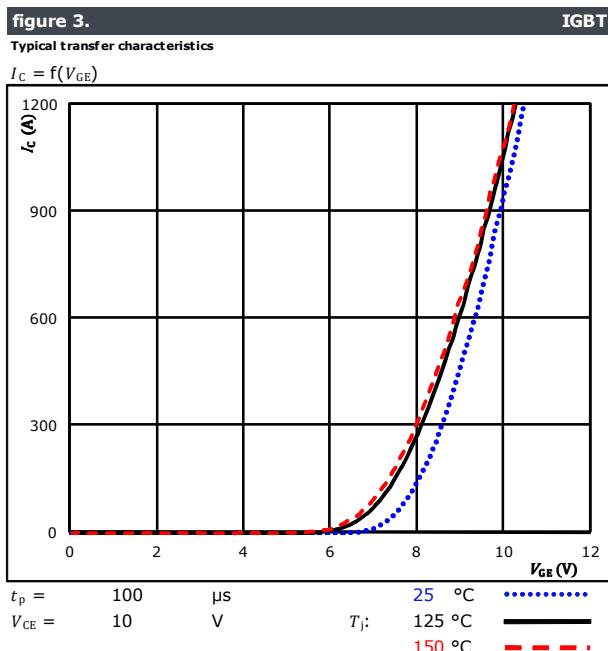
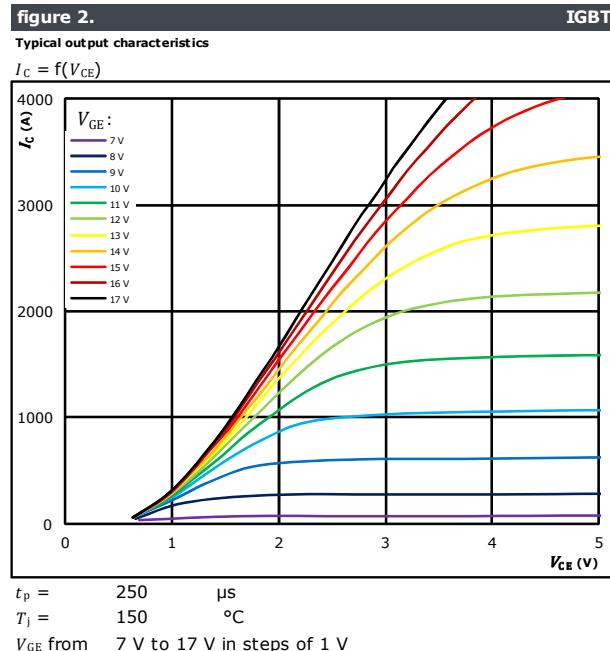
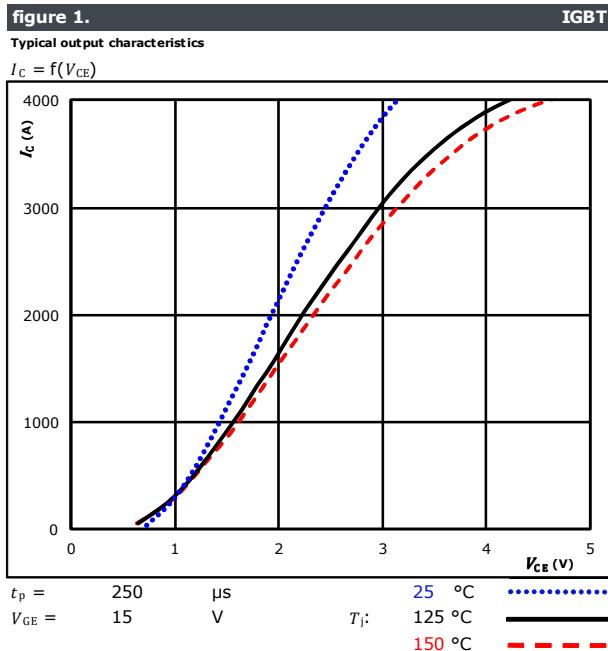
Thermistor

Rated resistance	R				25		22			kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$			100	-5		5		%
Power dissipation	P				25		5			mW
Power dissipation constant					25		1,5			mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %			25		3962			K
B-value	$B_{(25/100)}$	Tol. ±1 %			25		4000			K
Vincotech NTC Reference								I		



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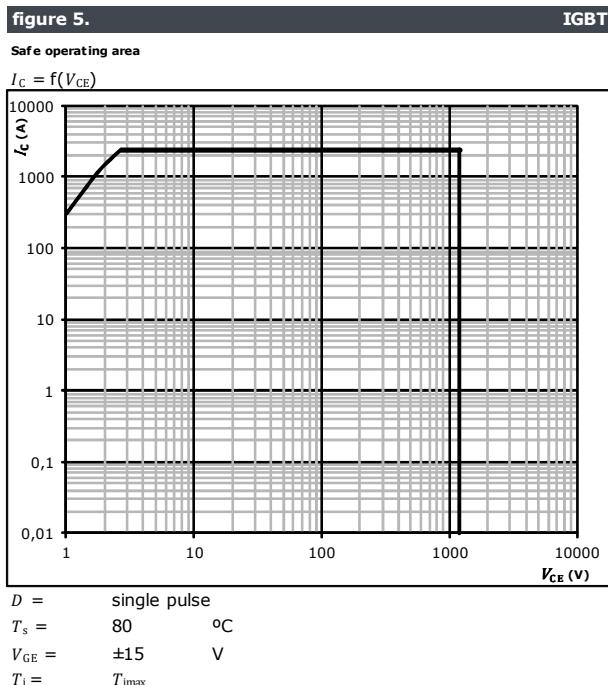
Buck Switch Characteristics





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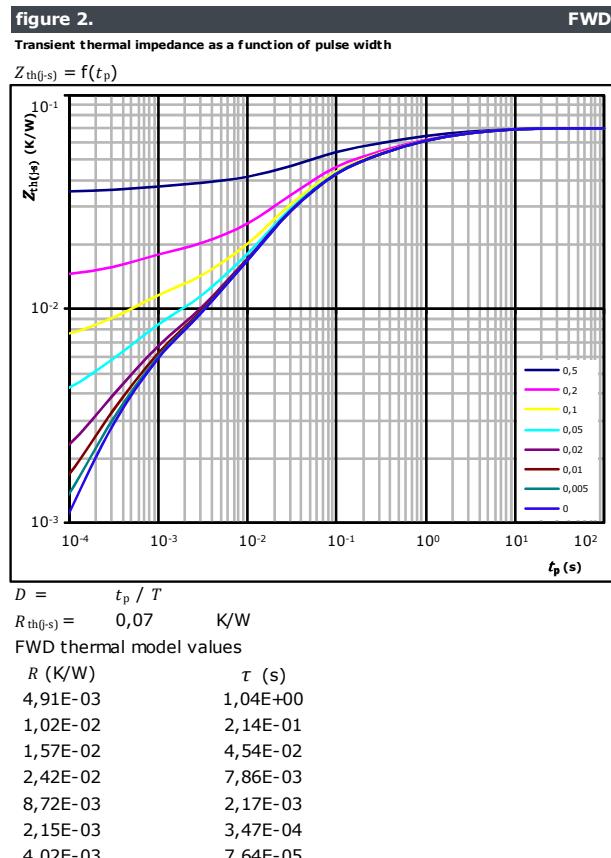
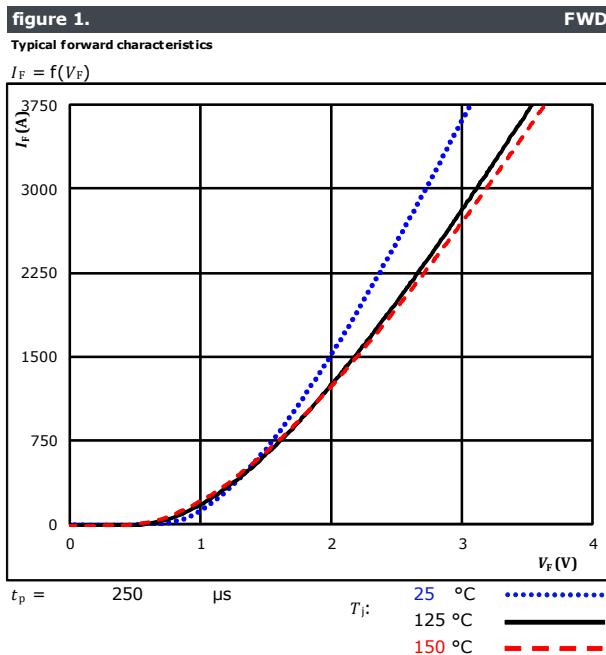
Buck Switch Characteristics





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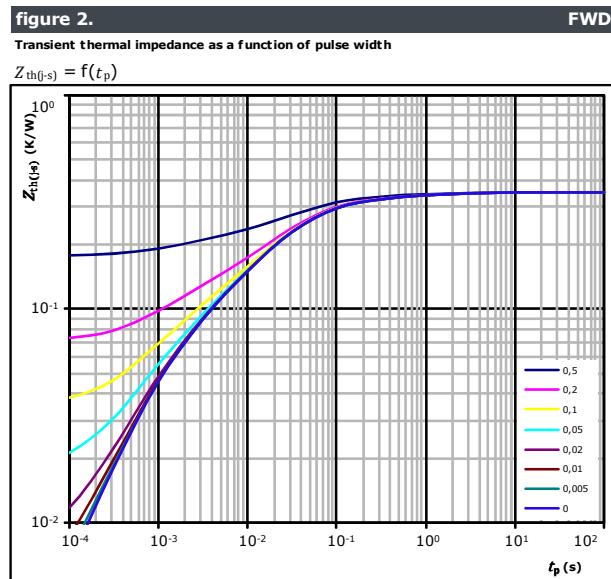
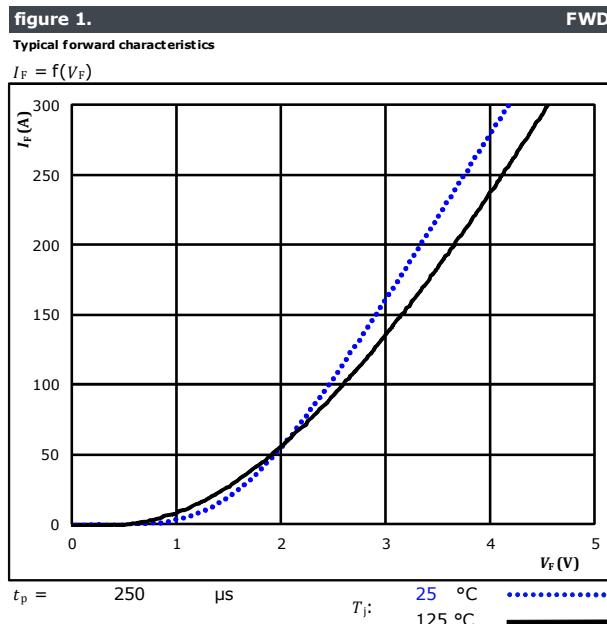
Buck Diode Characteristics





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Buck Sw. Protection Diode Characteristics



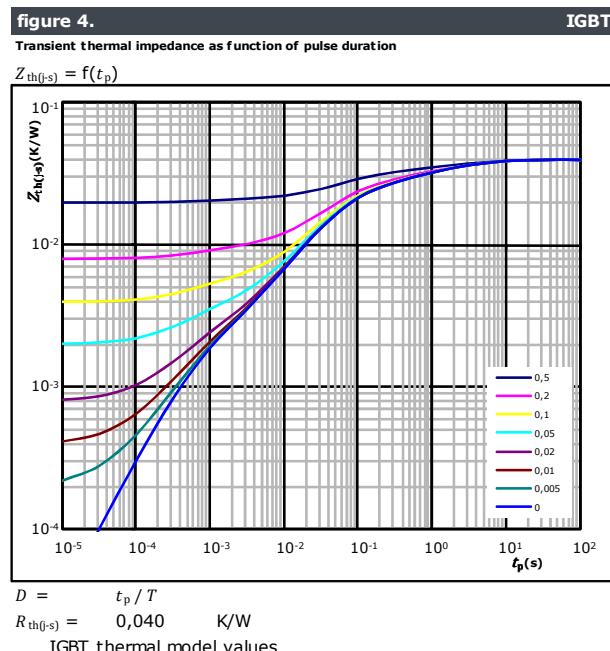
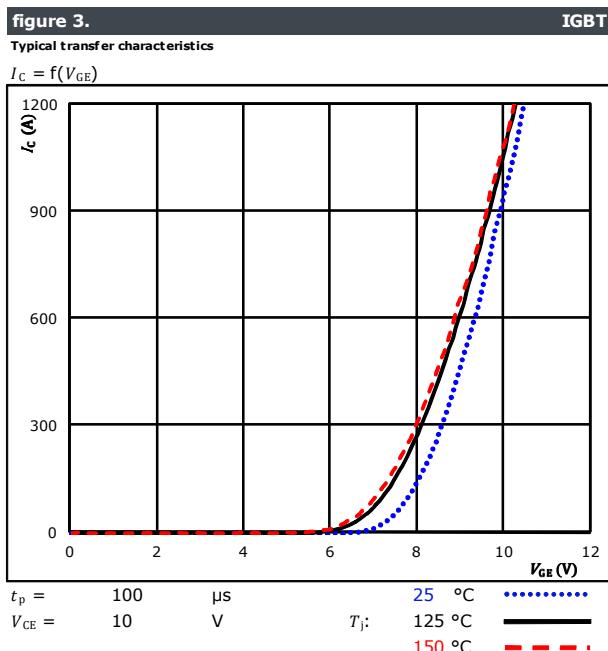
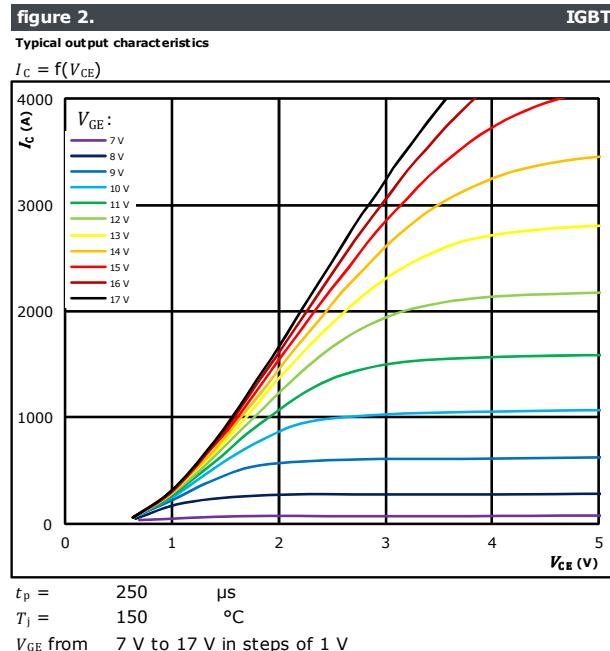
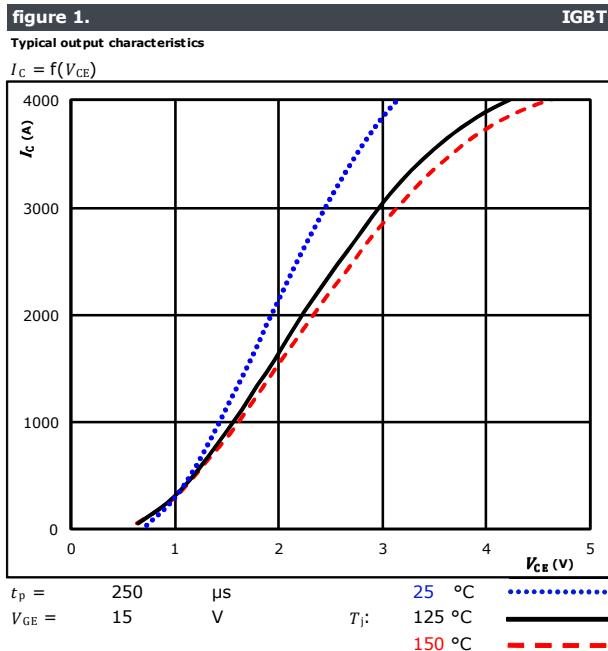
FWD thermal model values

$R (\text{K}/\text{W})$	$\tau (\text{s})$
1,68E-02	5,53E-01
3,42E-02	7,61E-02
1,32E-01	1,28E-02
9,39E-02	3,66E-03
3,70E-02	9,02E-04
3,86E-02	2,43E-04



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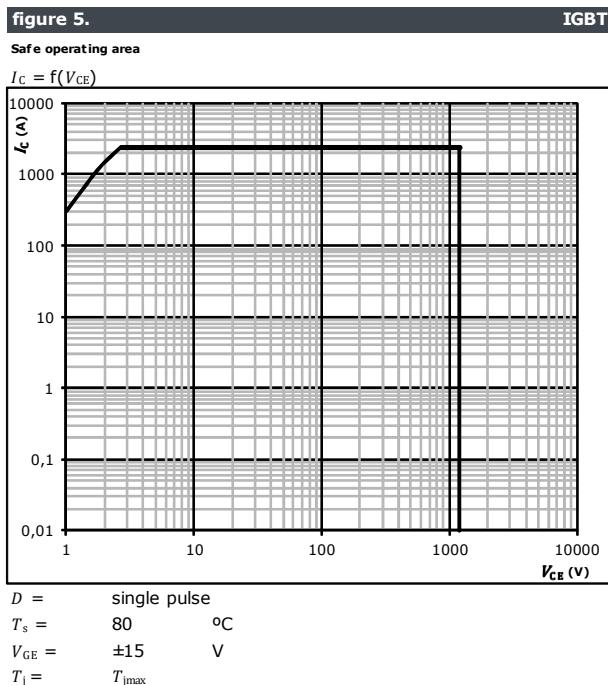
Boost Switch Characteristics





Vincotech

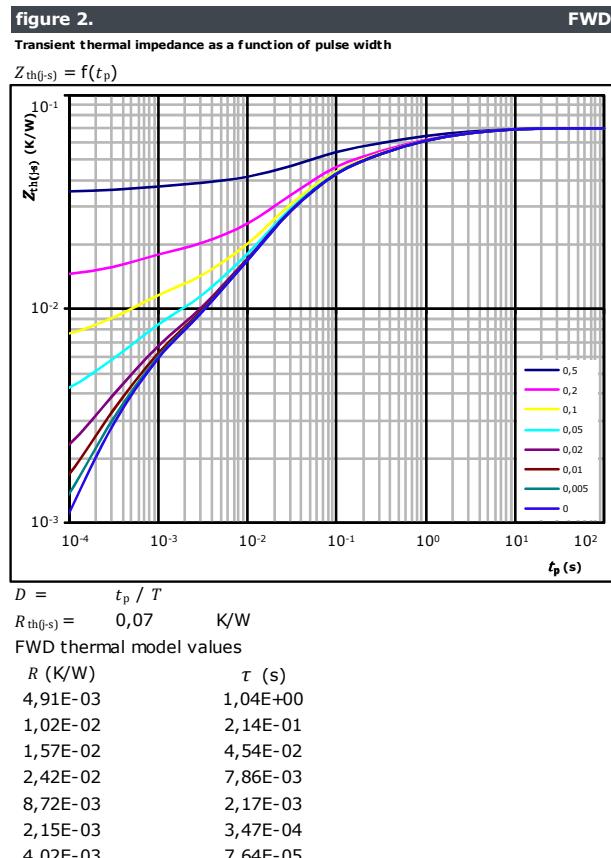
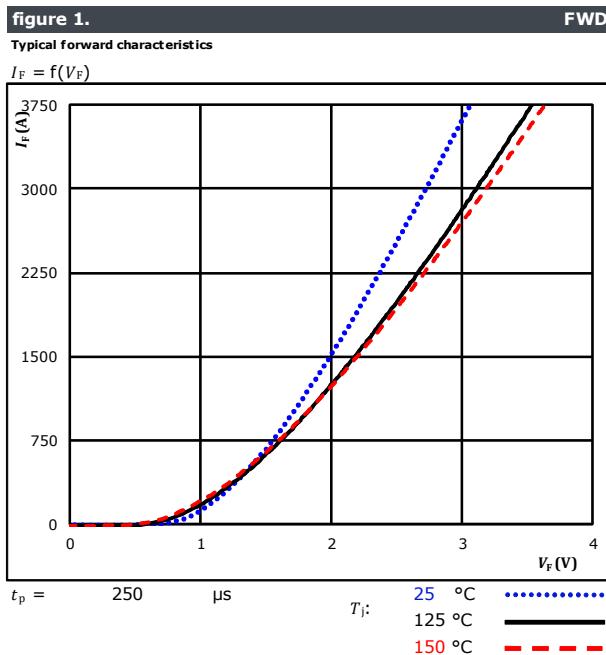
Boost Switch Characteristics





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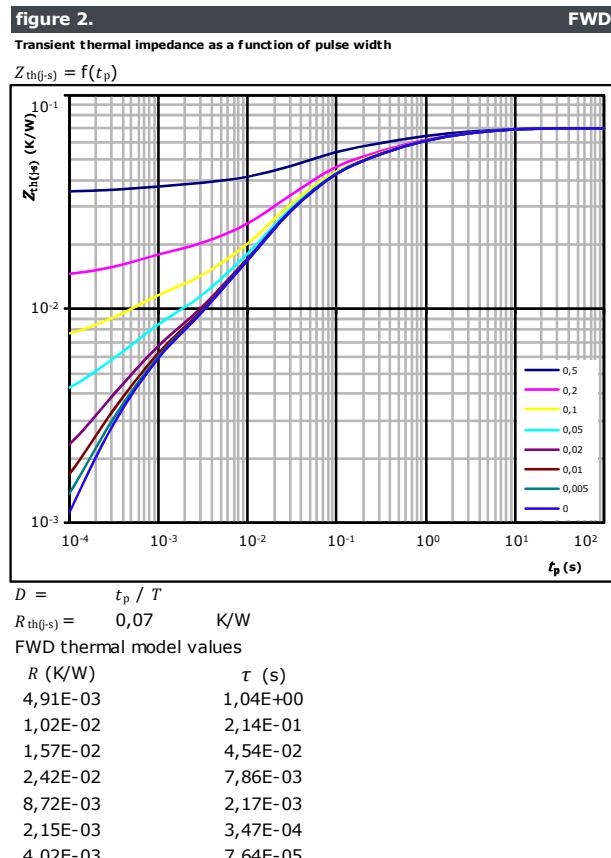
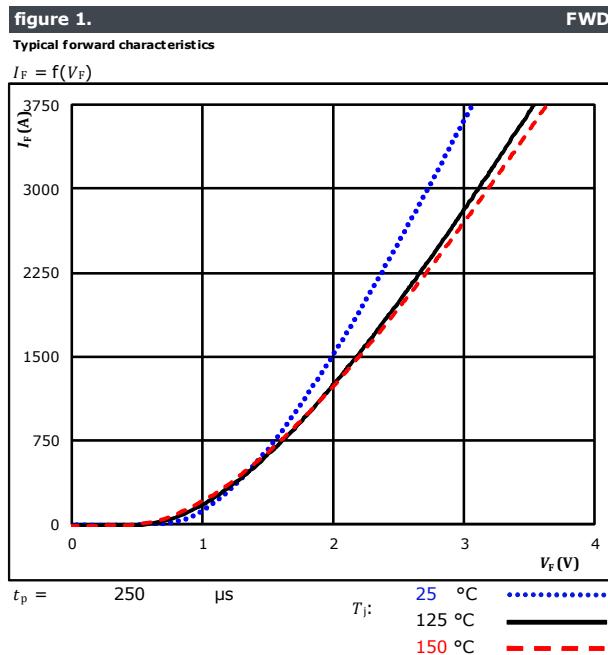
Boost Diode Characteristics





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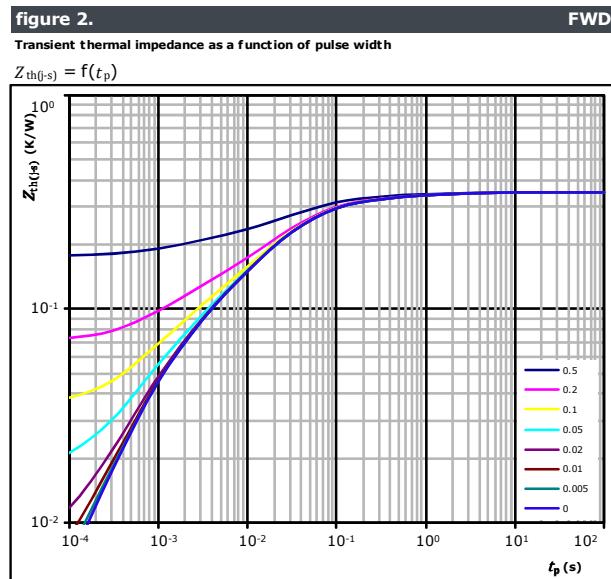
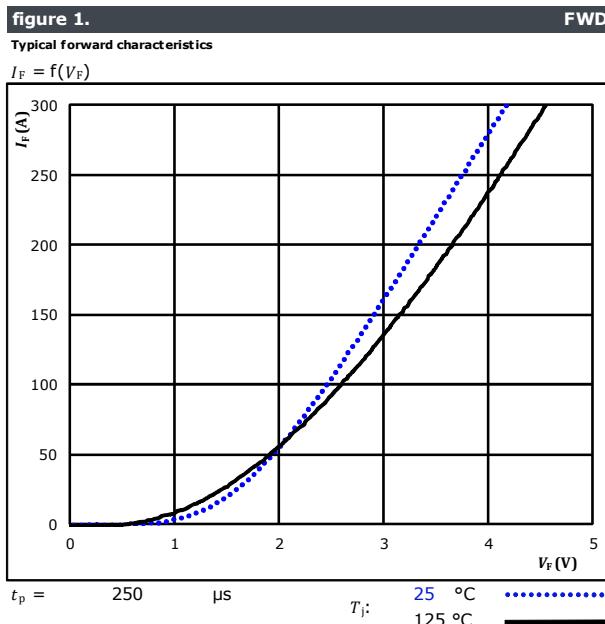
Boost Sw.Inv.Diode Characteristics





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Boost Sw. Protection Diode Characteristics



FWD thermal model values

R (K/W)	τ (s)
1,68E-02	5,53E-01
3,42E-02	7,61E-02
1,32E-01	1,28E-02
9,39E-02	3,66E-03
3,70E-02	9,02E-04
3,86E-02	2,43E-04



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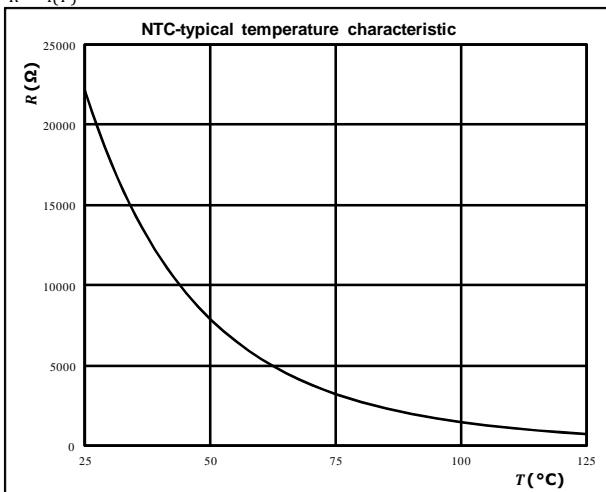
Thermistor Characteristics

figure 1.

Thermistor

Typical NTC characteristic
as a function of temperature

$$R = f(T)$$





70-W624NIA1K2M702-L400FP70

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Buck Switching Characteristics

figure 1.

Typical switching energy losses as a function of collector current

IGBT

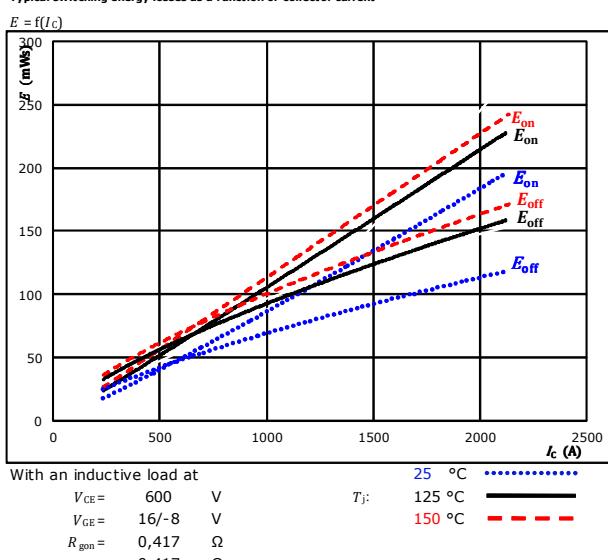
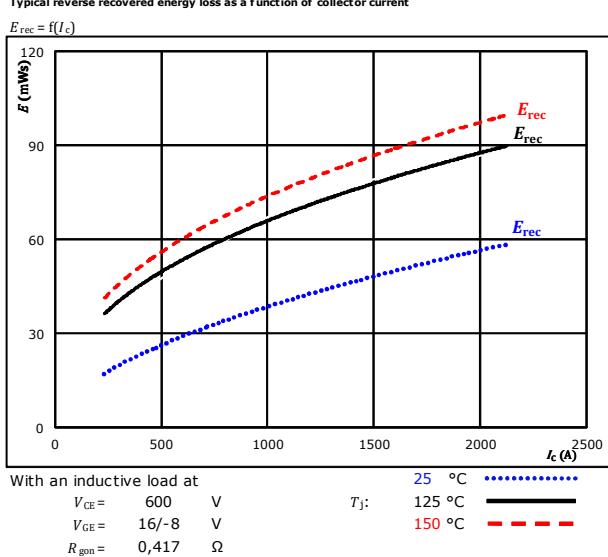


figure 2.

Typical reverse recovered energy loss as a function of collector current

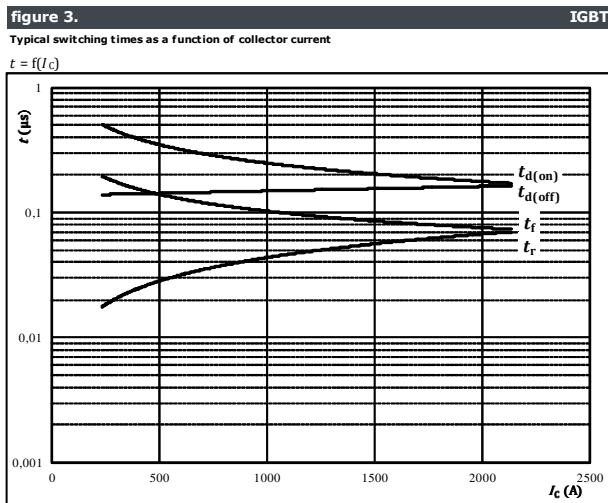
FWD





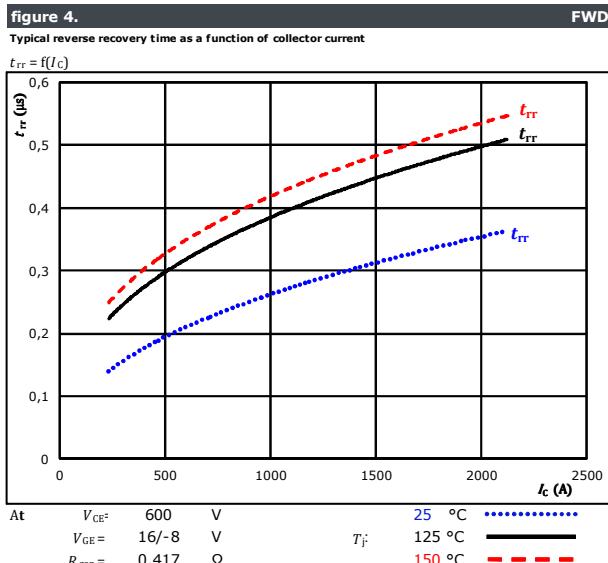
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Buck Switching Characteristics



With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	16/-8	V
$R_{gon} =$	0,417	Ω
$R_{goff} =$	0,417	Ω

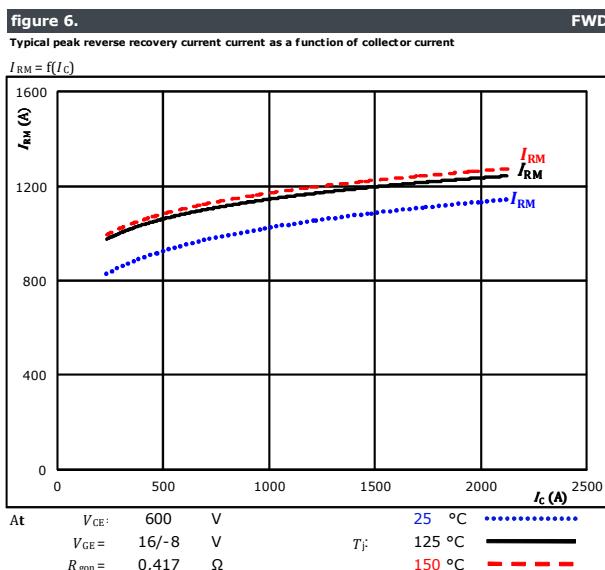
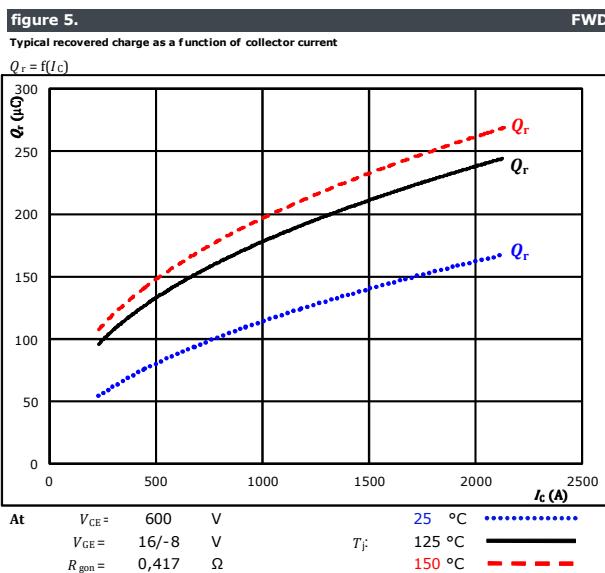


At	$V_{CE} =$	600	V	$25^\circ C$
	$V_{GE} =$	16/-8	V	$125^\circ C$	—
	$R_{gon} =$	0,417	Ω	$150^\circ C$	- - -



Vincotech

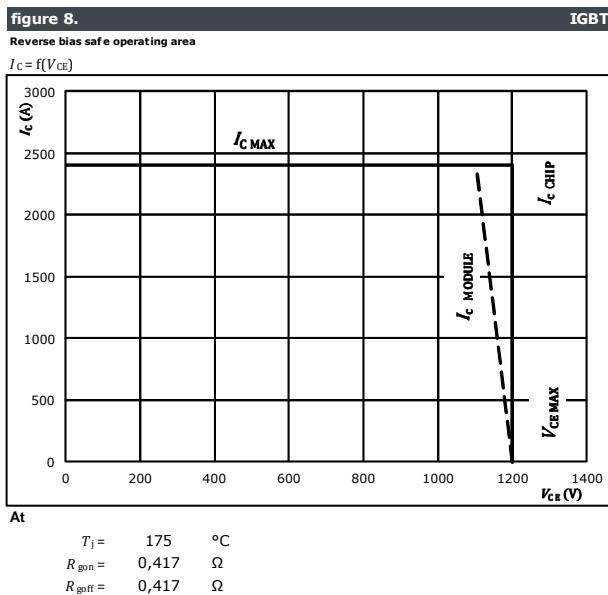
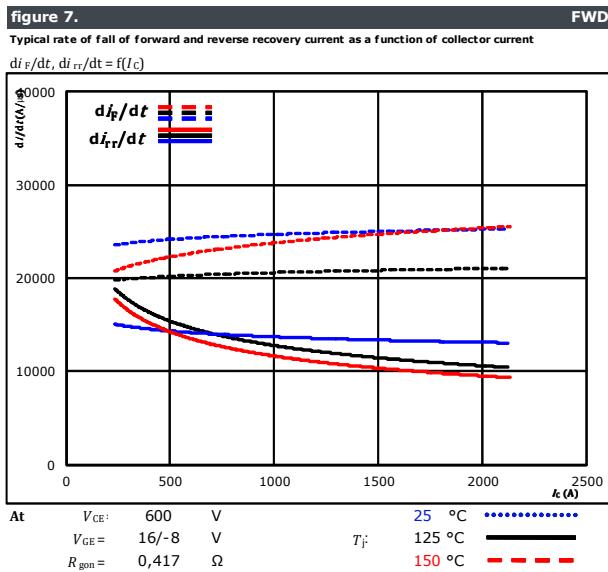
Buck Switching Characteristics





Vincotech

Buck Switching Characteristics



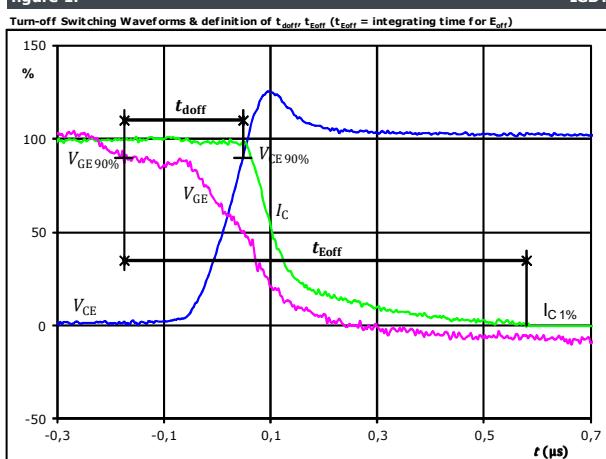


Vincotech

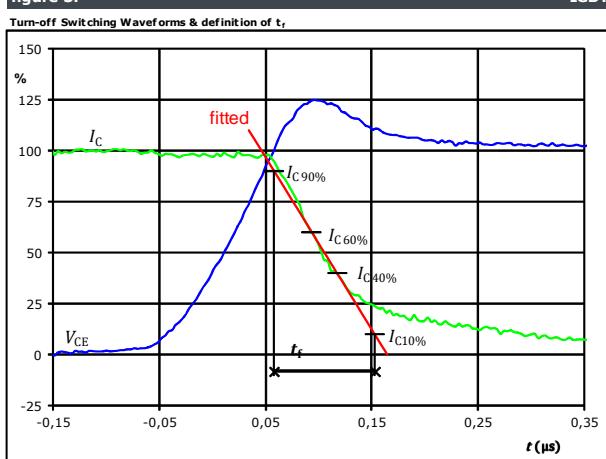
Buck Switching Definitions

General conditions

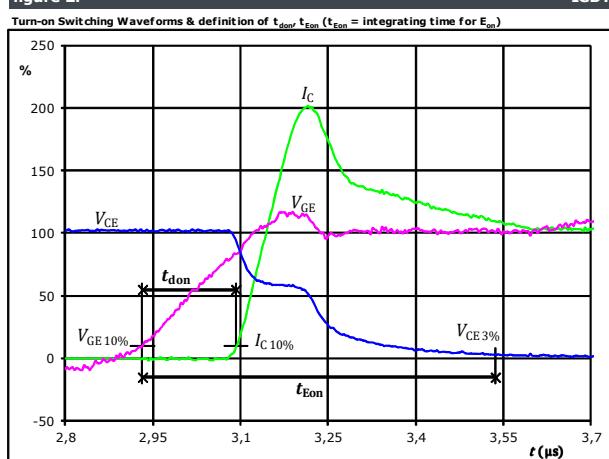
T_j	=	125 °C
R_{gon}	=	0,417 Ω
R_{goff}	=	0,417 Ω

figure 1.

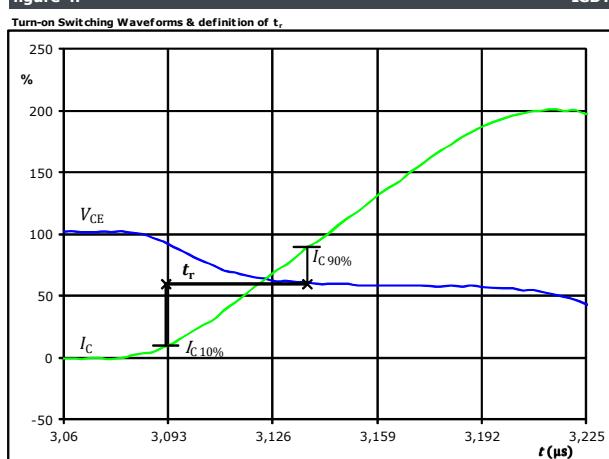
$V_{GE}(0\%) = -8 \text{ V}$
 $V_{GE}(100\%) = 16 \text{ V}$
 $V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 1209 \text{ A}$
 $t_{doff} = 0,249 \mu\text{s}$
 $t_{Eoff} = 0,754 \mu\text{s}$

figure 3.

$V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 1209 \text{ A}$
 $t_f = 0,085 \mu\text{s}$

figure 2.

$V_{GE}(0\%) = -8 \text{ V}$
 $V_{GE}(100\%) = 16 \text{ V}$
 $V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 1209 \text{ A}$
 $t_{don} = 0,152 \mu\text{s}$
 $t_{Eon} = 0,604 \mu\text{s}$

figure 4.

$V_C(100\%) = 600 \text{ V}$
 $I_C(100\%) = 1209 \text{ A}$
 $t_r = 0,045 \mu\text{s}$

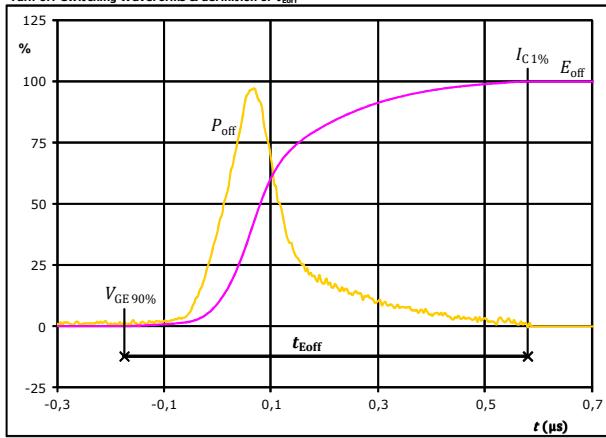


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Buck Switching Characteristics

figure 5.

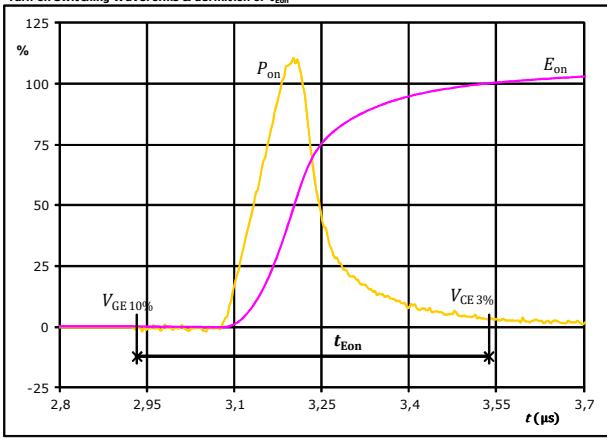
IGBT

Turn-off Switching Waveforms & definition of t_{Eoff} 

$P_{off}(100\%) = 725,65 \text{ kW}$
 $E_{off}(100\%) = 108,21 \text{ mJ}$
 $t_{Eoff} = 0,75 \mu\text{s}$

figure 6.

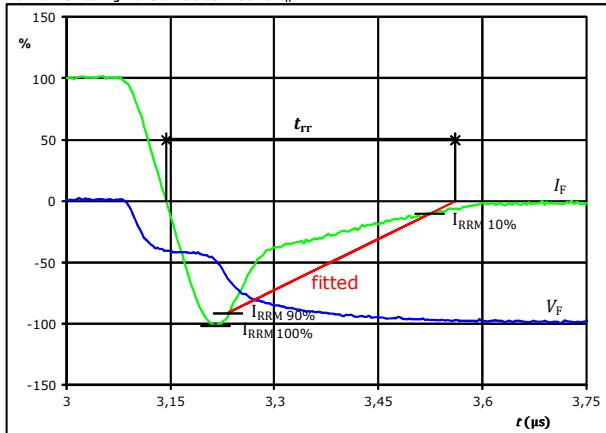
IGBT

Turn-on Switching Waveforms & definition of t_{Eon} 

$P_{on}(100\%) = 725,65 \text{ kW}$
 $E_{on}(100\%) = 109,70 \text{ mJ}$
 $t_{Eon} = 0,60 \mu\text{s}$
 $V_{CE 3\%}$

figure 7.

FWD

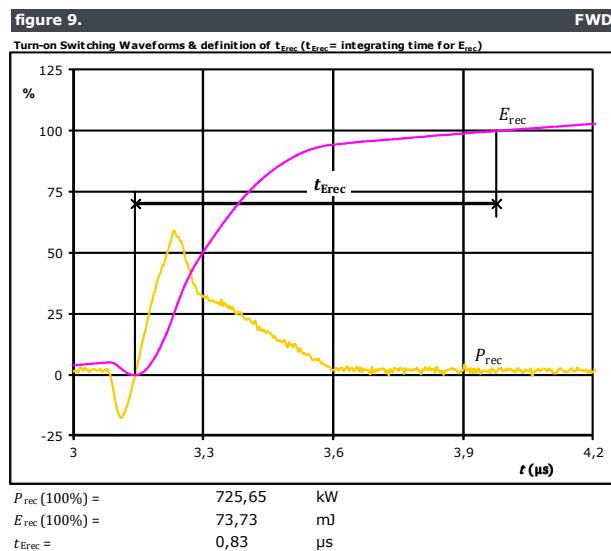
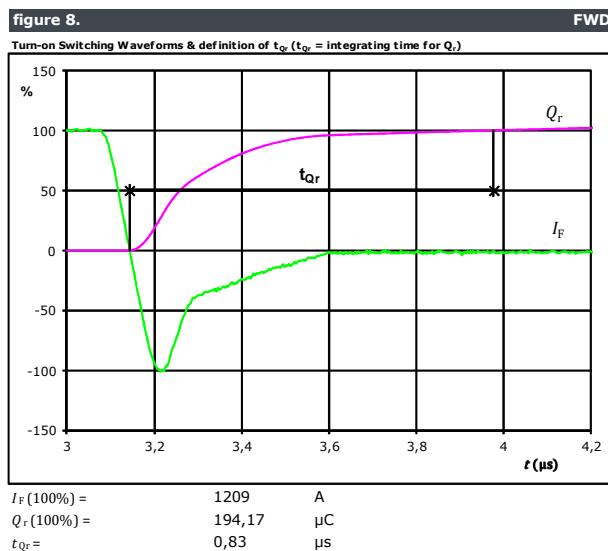
Turn-off Switching Waveforms & definition of t_{tr} 

$V_F(100\%) = 600 \text{ V}$
 $I_F(100\%) = 1209 \text{ A}$
 $I_{RRM}(100\%) = -1228 \text{ A}$
 $t_{tr} = 0,408 \mu\text{s}$



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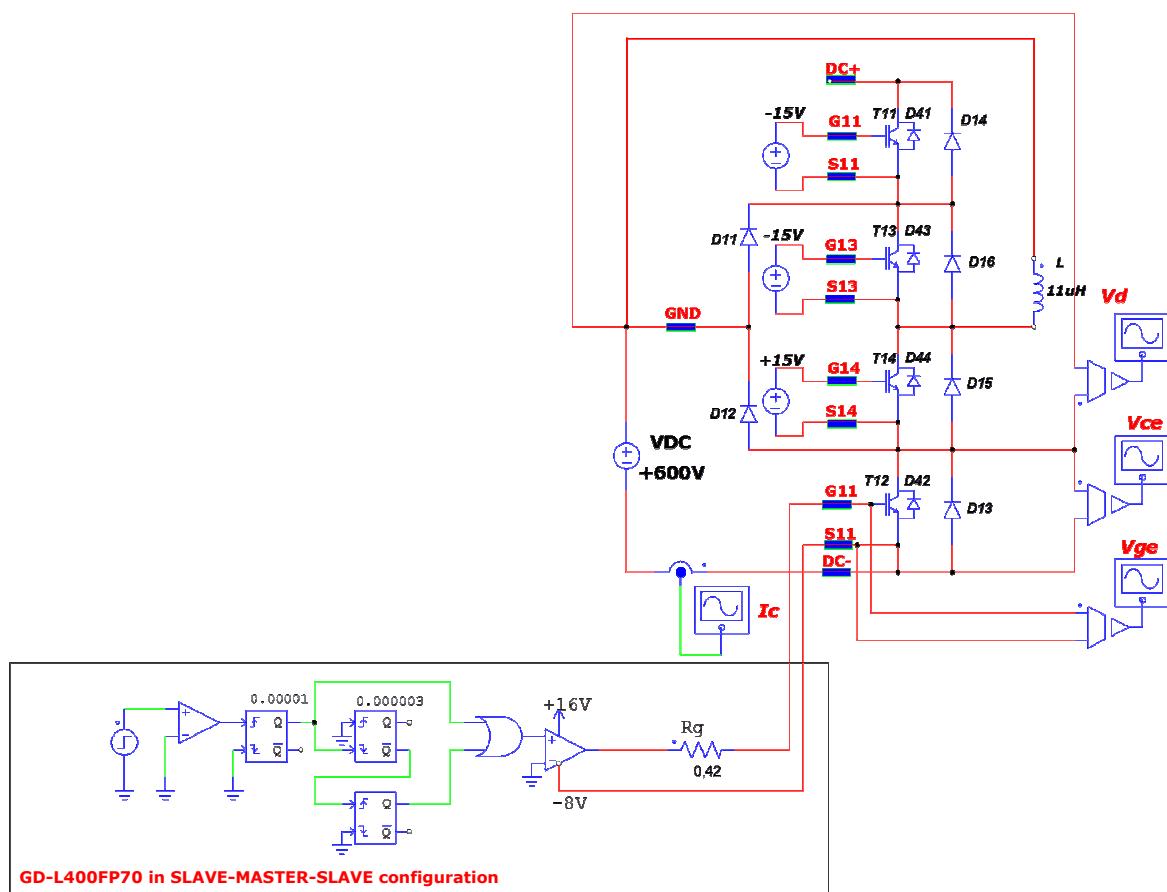
Buck Switching Characteristics



Gate Driver at measurement

For more information see L40x gate driver application note

T12-D12 Switching measurement circuit





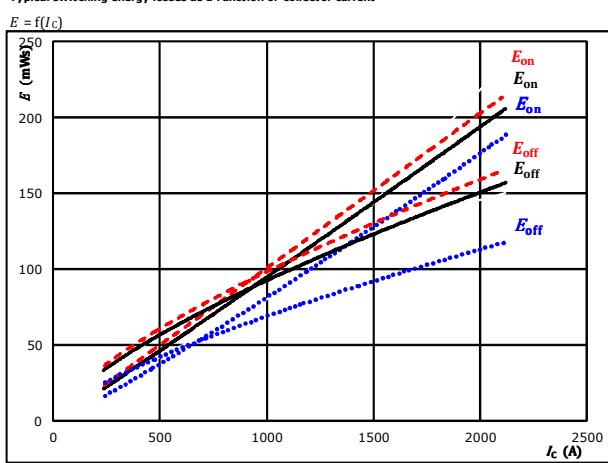
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Boost Switching Characteristics

figure 1.

Typical switching energy losses as a function of collector current

IGBT

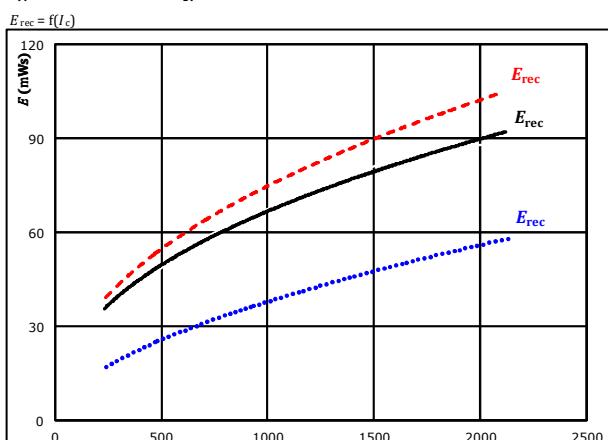


With an inductive load at

 25°C
..... $T_j: 125^\circ\text{C}$ ————
..... $V_{CE} = 600 \text{ V}$
 $V_{GE} = 16/-8 \text{ V}$
 $R_{gon} = 0,417 \Omega$
 $R_{goff} = 0,417 \Omega$ **figure 2.**

Typical reverse recovered energy loss as a function of collector current

FWD



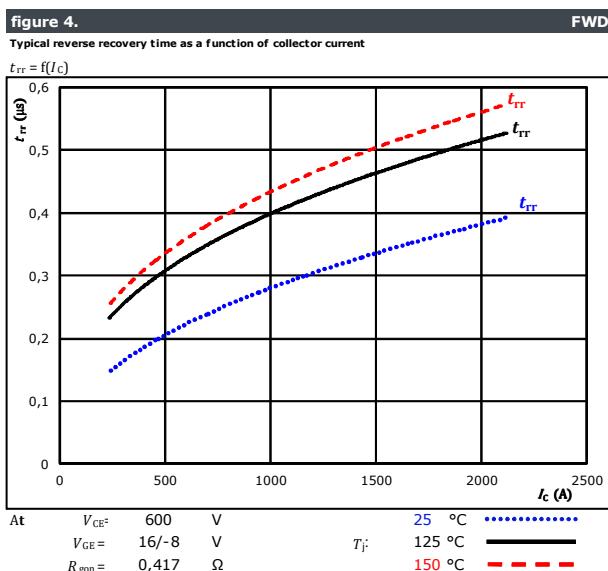
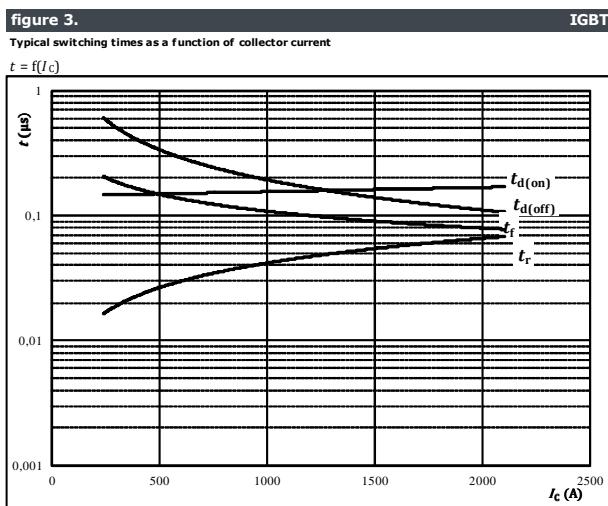
With an inductive load at

 25°C
..... $T_j: 125^\circ\text{C}$ ————
..... $V_{CE} = 600 \text{ V}$
 $V_{GE} = 16/-8 \text{ V}$
 $R_{gon} = 0,417 \Omega$



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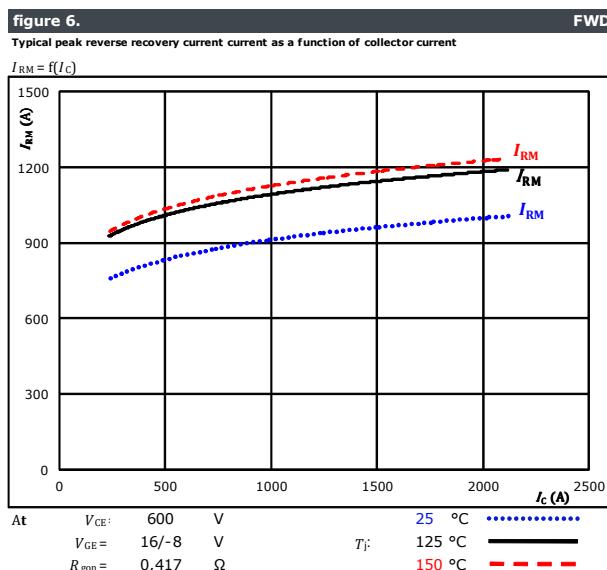
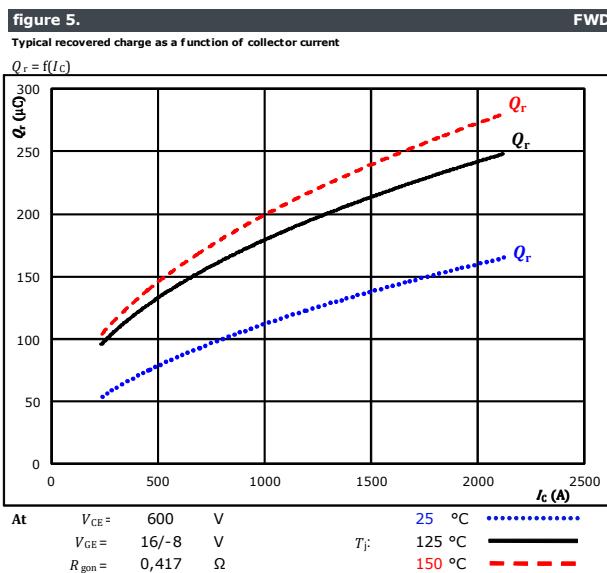
Boost Switching Characteristics





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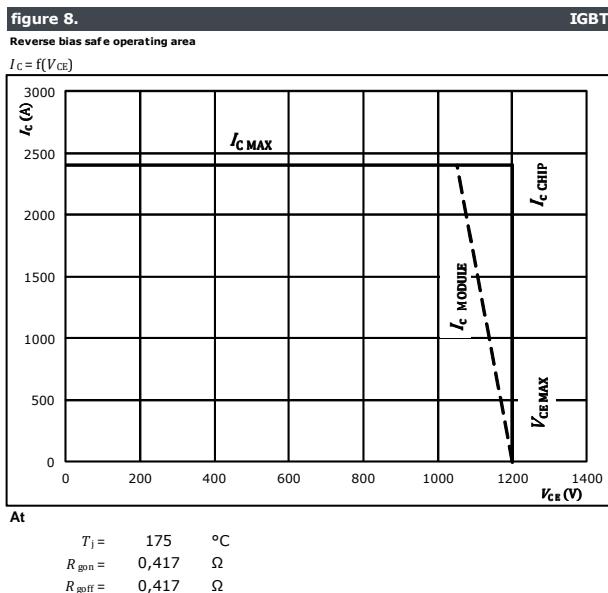
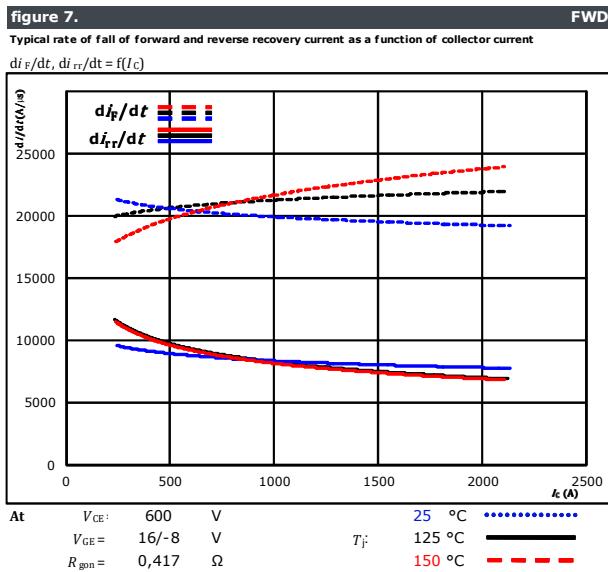
Boost Switching Characteristics





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Boost Switching Characteristics

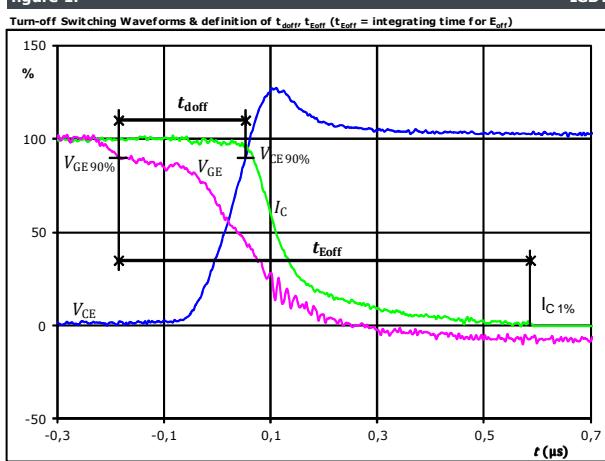



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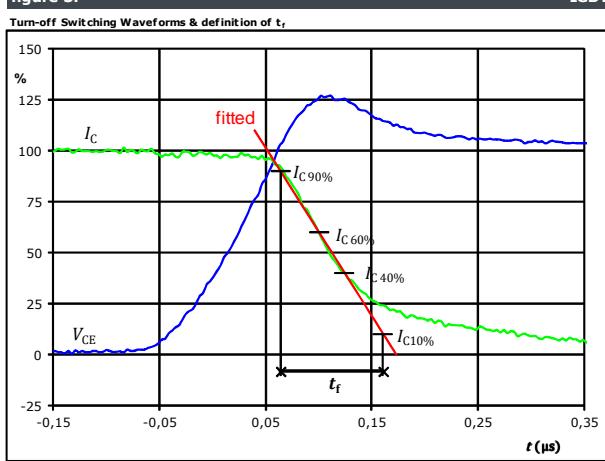
Boost Switching Definitions

General conditions

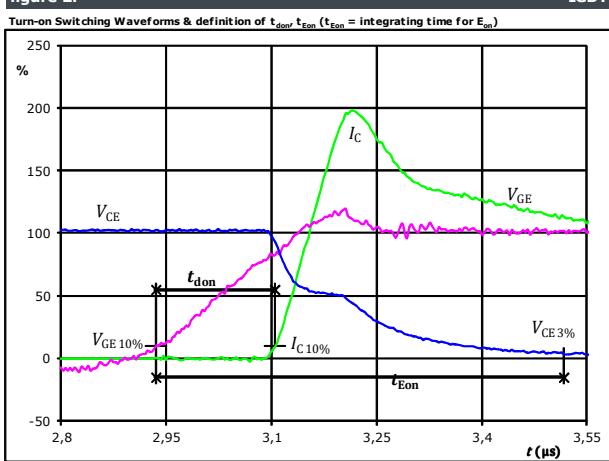
T_j	=	125 °C
R_{gon}	=	0,417 Ω
R_{goff}	=	0,417 Ω

figure 1.

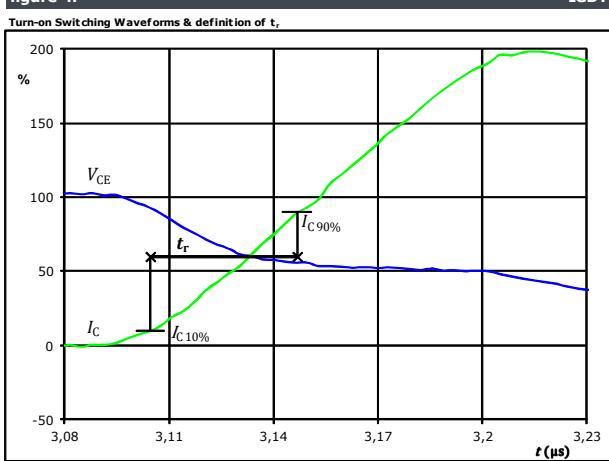
$V_{GE}(0\%) =$	-8	V
$V_{GE}(100\%) =$	16	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	1180	A
$t_{doff} =$	0,250	μs
$t_{Eoff} =$	0,772	μs

figure 3.

$V_C(100\%) =$	600	V
$I_C(100\%) =$	1180	A
$t_f =$	0,095	μs

figure 2.

$V_{GE}(0\%) =$	-8	V
$V_{GE}(100\%) =$	16	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	1180	A
$t_{don} =$	0,156	μs
$t_{Eon} =$	0,582	μs

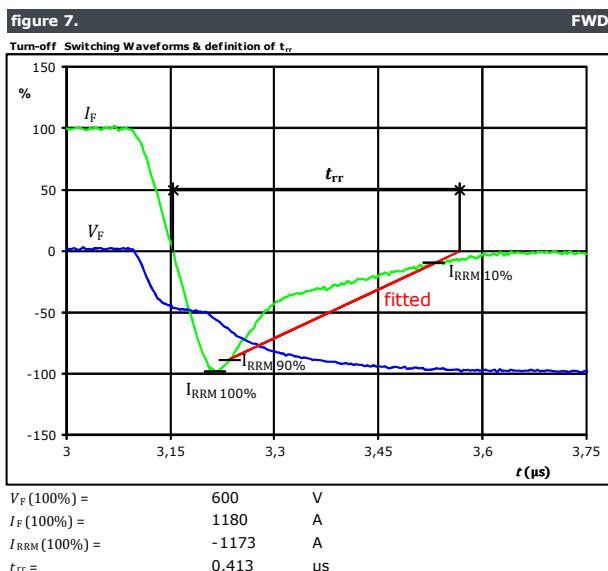
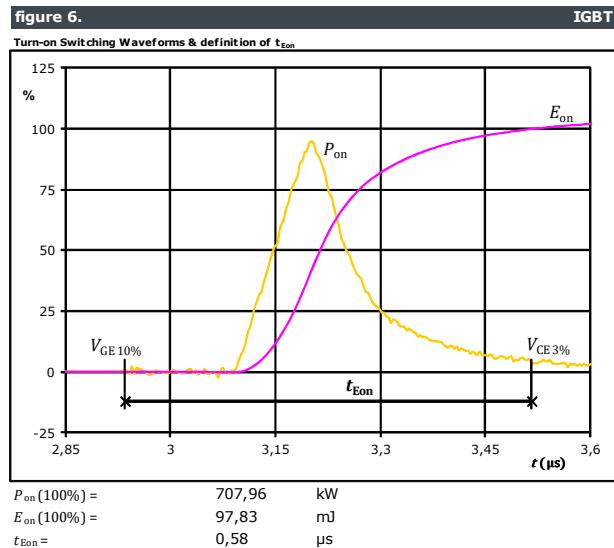
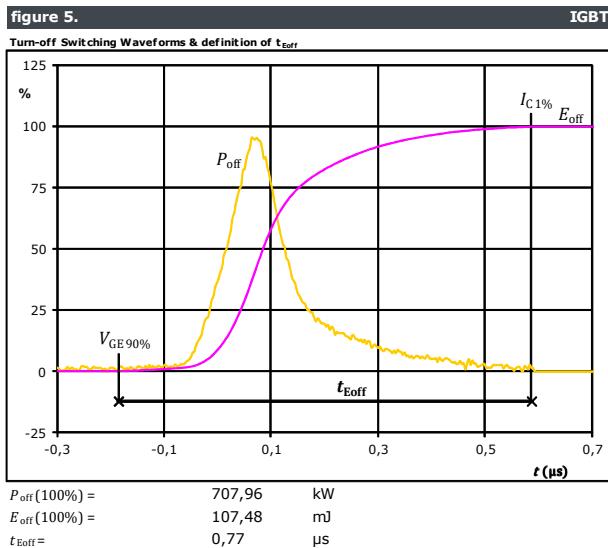
figure 4.

$V_C(100\%) =$	600	V
$I_C(100\%) =$	1180	A
$t_r =$	0,042	μs



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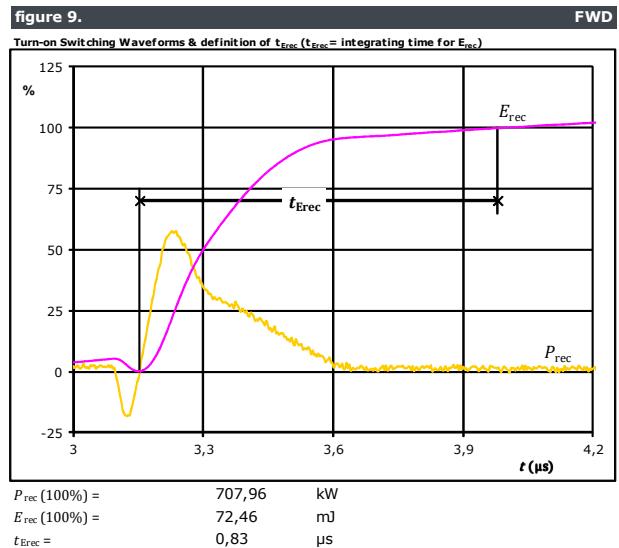
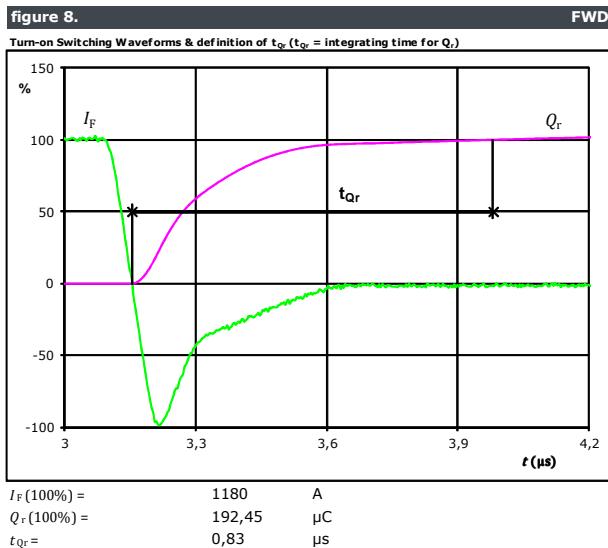
Boost Switching Characteristics





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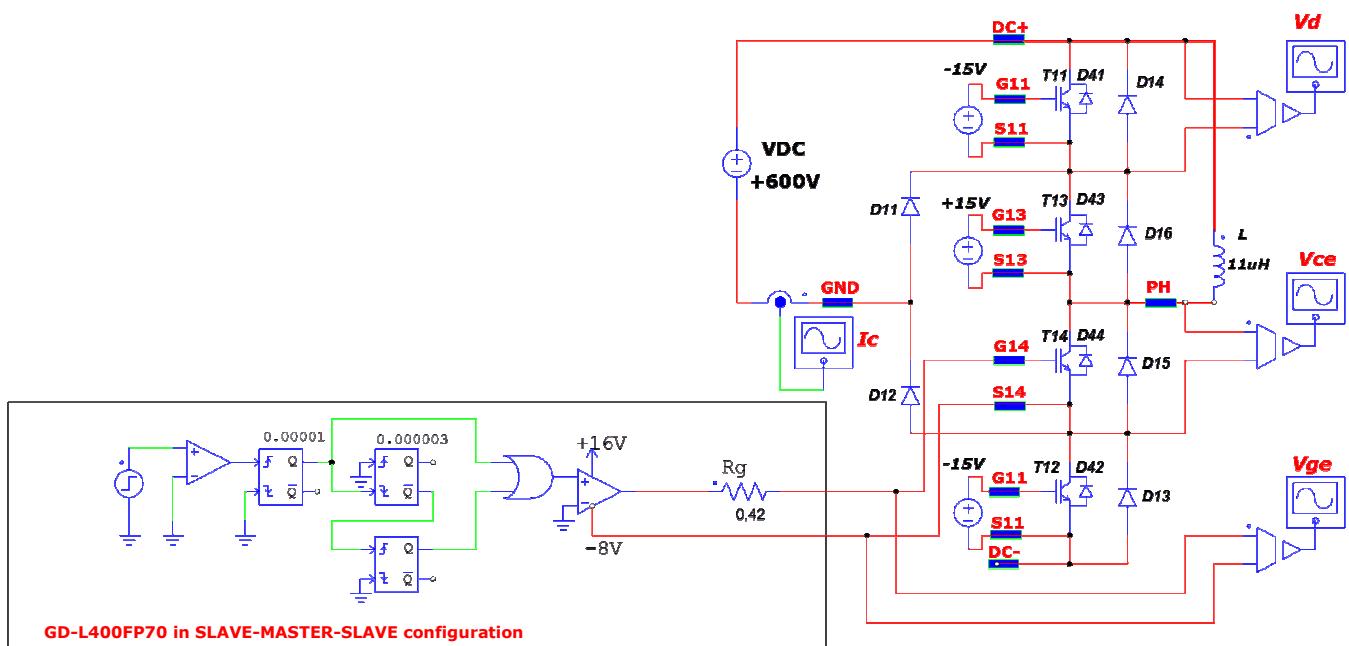
Boost Switching Characteristics



Gate Driver at measurement

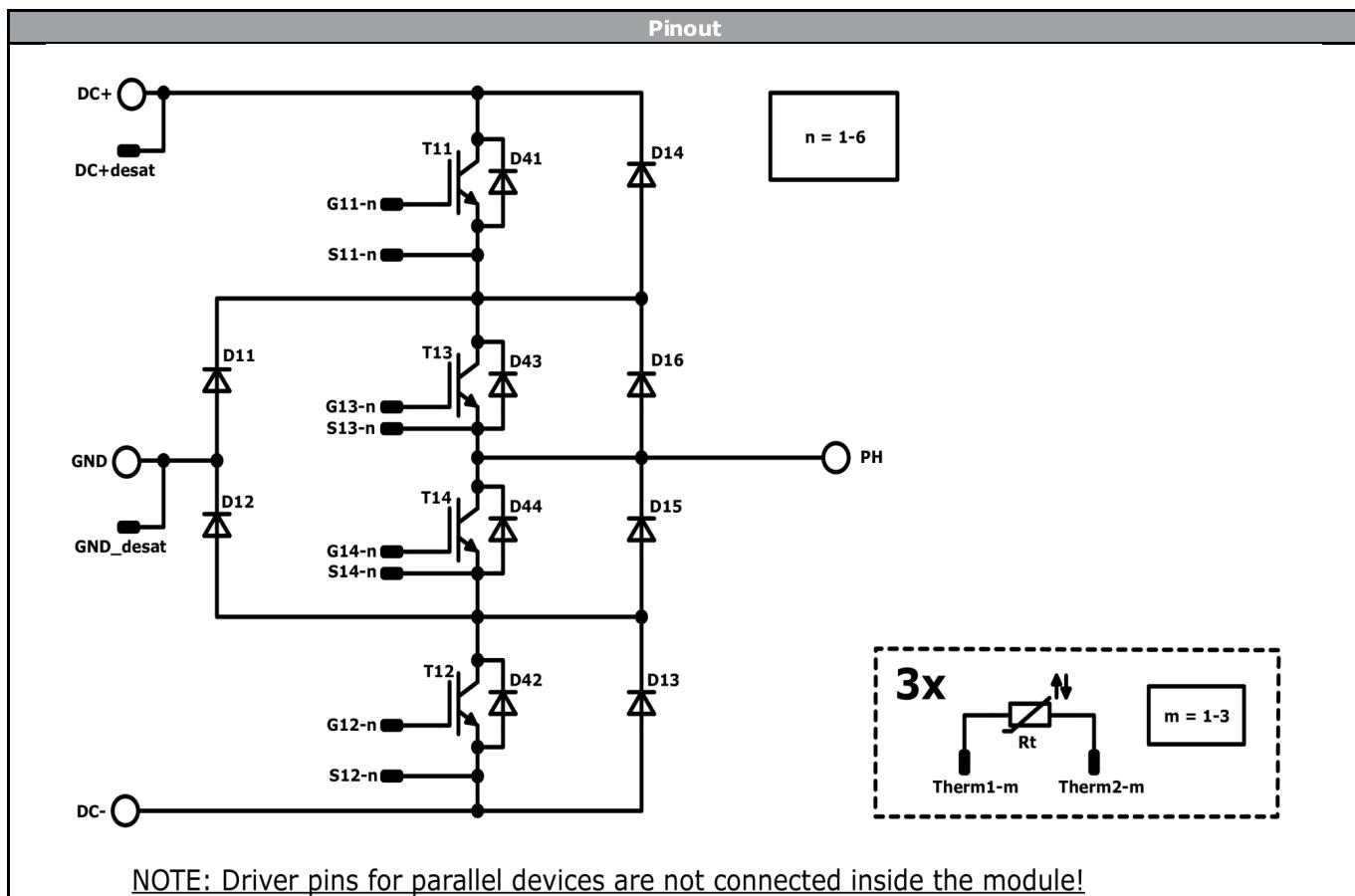
For more information see L40x gate driver application note

T14-D14 Switching measurement circuit





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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12	IGBT	1200 V	1200 A	Buck Switch	
D11, D12	FWD	1200 V	1200 A	Buck Diode	
D41, D42	FWD	1200 V	90 A	Buck Sw. Protection Diode	
T13, T14	IGBT	1200 V	1200 A	Boost Switch	
D13, D14	FWD	1200 V	1200 A	Boost Diode	
D16, D15	FWD	1200 V	1200 A	Boost Sw. Inv. Diode	
D43, D44	FWD	1200 V	90 A	Boost Sw. Protection Diode	
Rt	Thermistor			Thermistor	



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Packaging instruction			
Standard packaging quantity (SPQ) 4	>SPQ	Standard	<SPQ Sample

Handling instruction			
Handling instructions for VINco X12 packages see vincotech.com website.			

Package data			
Package data for VINco X12 packages see vincotech.com website.			

UL recognition and file number			
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.			

Document No.:	Date:	Modification:	Pages
70-W624NIA1K2M702-L400FP70-D3-14	08 July 2021	Pin coordinates corrected	33

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